

## High Temperature Silicon Carbide Power Schottky Diode

$V_{RRM}$	=	1200 V
$I_F$ ( $T_C=25^\circ\text{C}$ )	=	8 A
$Q_C$	=	17 nC

### Features

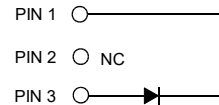
- 1200 V Schottky rectifier
- 210 °C maximum operating temperature
- Electrically isolated base-plate
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of  $V_F$
- Temperature independent switching behavior
- Lowest figure of merit  $Q_C/I_F$
- Available screened to Mil-PRF-19500

### Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

### Package

- RoHS Compliant



**TO – 257 (Isolated Base-plate Hermetic Package)**

### Applications

- Down Hole Oil Drilling
- Geothermal Instrumentation
- Solenoid Actuators
- General Purpose High-Temperature Switching
- Amplifiers
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)

### Maximum Ratings at $T_j = 210^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Values		Unit
			min.	typ.	
Repetitive peak reverse voltage	$V_{RRM}$			1200	V
Continuous forward current	$I_F$	$T_C = 25^\circ\text{C}$		8	A
Continuous forward current	$I_F$	$T_C \leq 190^\circ\text{C}$		2.5	A
RMS forward current	$I_{F(RMS)}$	$T_C \leq 190^\circ\text{C}$		4.3	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}$ , $t_p = 10\text{ ms}$		30	A
Non-repetitive peak forward current	$I_{F,max}$	$T_C = 25^\circ\text{C}$ , $t_p = 10\ \mu\text{s}$		120	A
$I^2t$ value	$\int I^2 dt$	$T_C = 25^\circ\text{C}$ , $t_p = 10\text{ ms}$		5	$\text{A}^2\text{S}$
Power dissipation	$P_{tot}$	$T_C = 25^\circ\text{C}$		66	W
Operating and storage temperature	$T_j, T_{stg}$			-55 to 210	$^\circ\text{C}$

### Electrical Characteristics at $T_j = 210^\circ\text{C}$ , unless otherwise specified

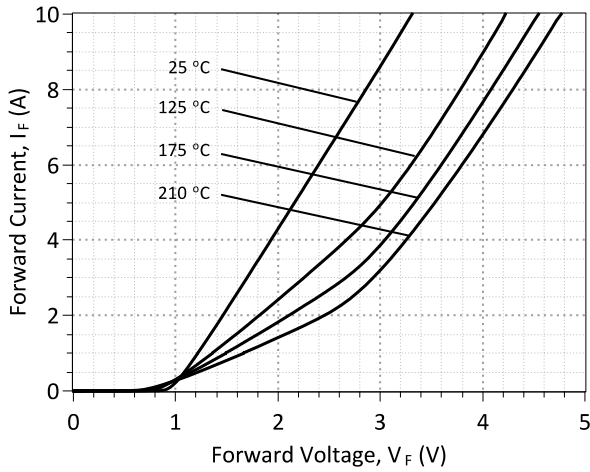
Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	$V_F$	$I_F = 2.5\text{ A}$ , $T_j = 25^\circ\text{C}$		1.6		V
		$I_F = 2.5\text{ A}$ , $T_j = 210^\circ\text{C}$		2.8		
Reverse current	$I_R$	$V_R = 1200\text{ V}$ , $T_j = 25^\circ\text{C}$		1	10	$\mu\text{A}$
		$V_R = 1200\text{ V}$ , $T_j = 210^\circ\text{C}$		25	200	
Total capacitive charge	$Q_C$	$I_F \leq I_{F,MAX}$ $dI_F/dt = 200\text{ A}/\mu\text{s}$ $T_j = 210^\circ\text{C}$	$V_R = 400\text{ V}$	17		nC
	$V_R = 960\text{ V}$		29			
Switching time	$t_s$	$V_R = 1\text{ V}$ , $f = 1\text{ MHz}$ , $T_j = 25^\circ\text{C}$ $V_R = 400\text{ V}$ , $f = 1\text{ MHz}$ , $T_j = 25^\circ\text{C}$ $V_R = 1000\text{ V}$ , $f = 1\text{ MHz}$ , $T_j = 25^\circ\text{C}$	$V_R = 400\text{ V}$	< 25		ns
			$V_R = 960\text{ V}$			
Total capacitance	C	$V_R = 1\text{ V}$ , $f = 1\text{ MHz}$ , $T_j = 25^\circ\text{C}$		237		pF
		$V_R = 400\text{ V}$ , $f = 1\text{ MHz}$ , $T_j = 25^\circ\text{C}$		25		
		$V_R = 1000\text{ V}$ , $f = 1\text{ MHz}$ , $T_j = 25^\circ\text{C}$		20		

### Thermal Characteristics

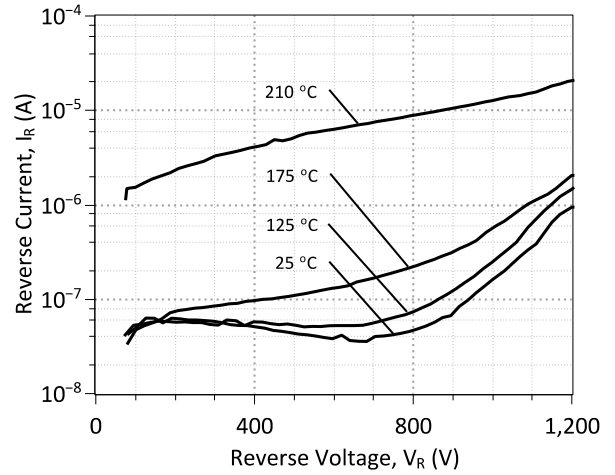
Thermal resistance, junction - case	$R_{thJC}$	3.4	$^\circ\text{C}/\text{W}$
-------------------------------------	------------	-----	---------------------------

### Mechanical Properties

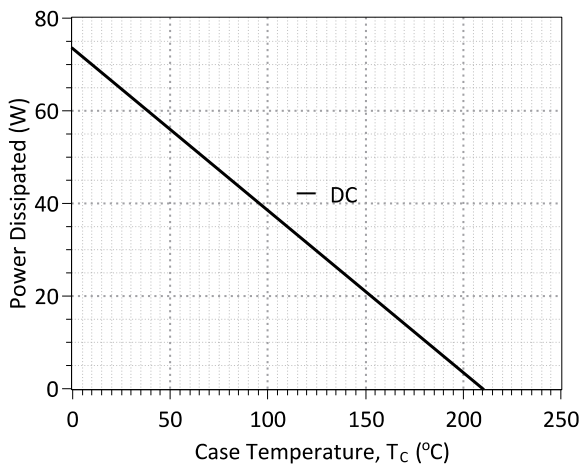
Mounting torque	M	0.6	Nm
-----------------	---	-----	----



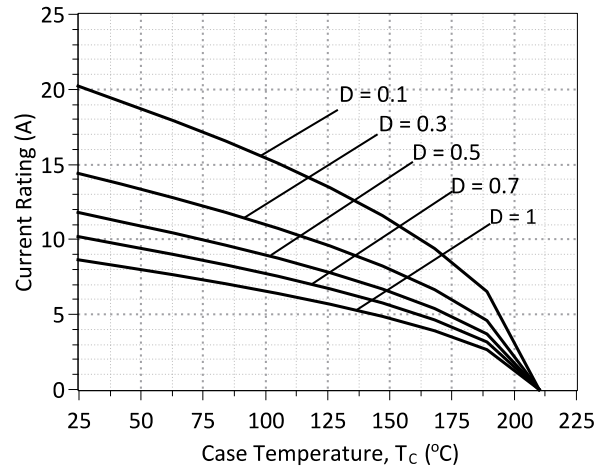
**Figure 1: Typical Forward Characteristics**



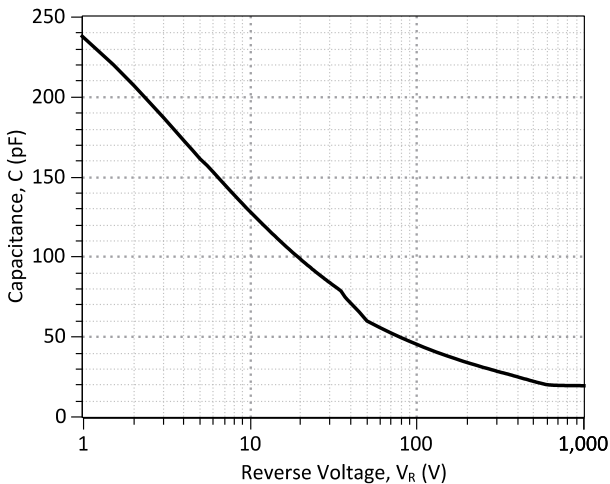
**Figure 2: Typical Reverse Characteristics**



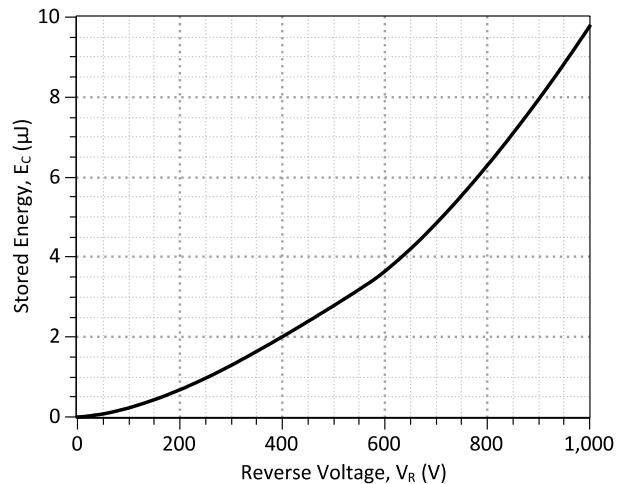
**Figure 3: Power Derating Curve**



**Figure 4: Current Derating Curves ( $D = t_p/T$ ,  $t_p = 400 \mu s$ )  
(Considering worst case  $Z_{th}$  conditions)**



**Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics**



**Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics**

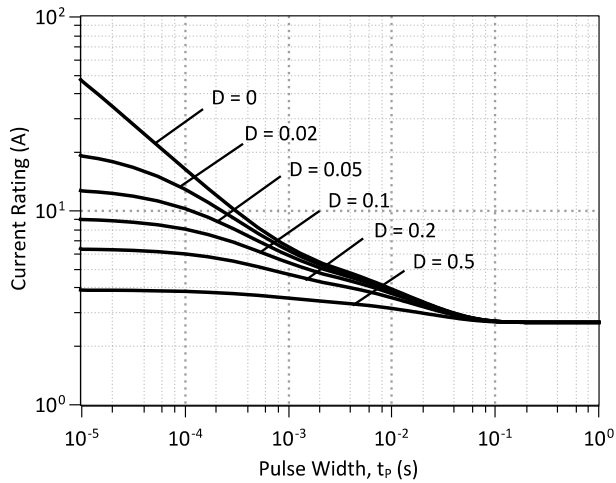


Figure 7: Current vs Pulse Duration Curves at  $T_c = 190\text{ }^\circ\text{C}$

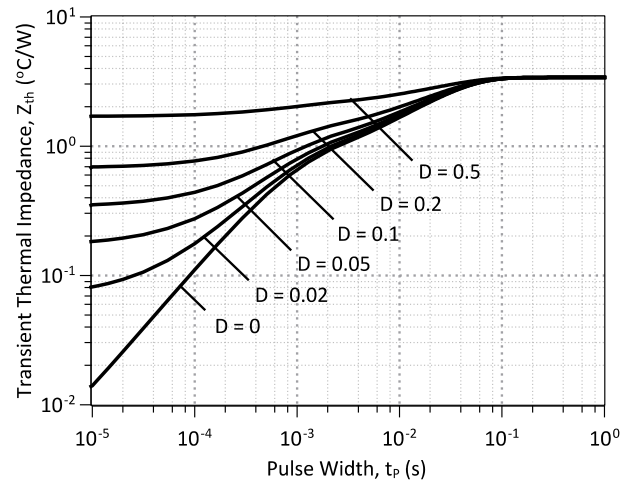
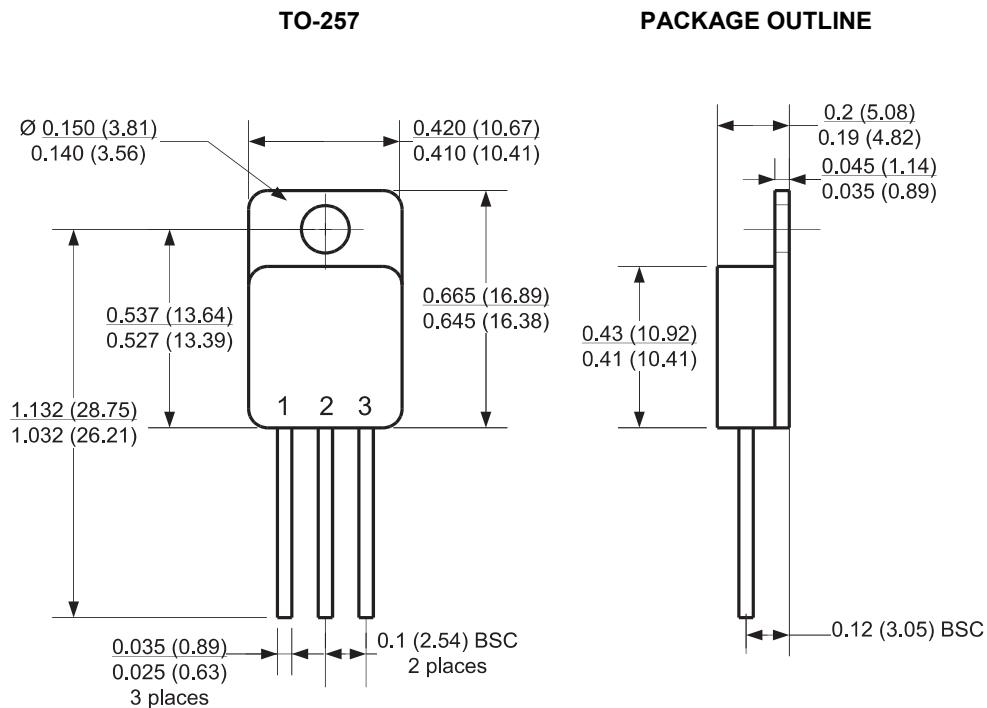


Figure 8: Transient Thermal Impedance

**Package Dimensions:**



**NOTE**

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

**Revision History**

Date	Revision	Comments	Supersedes
2014/08/26	1	Updated Electrical Characteristics	
2012/04/24	0	Initial release	

Published by

GeneSiC Semiconductor, Inc.  
43670 Trade Center Place Suite 155  
Dulles, VA 20166

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice.

GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.

## SPICE Model Parameters

This is a secure document. Copy this code from the SPICE model PDF file on our website into a SPICE software program for simulation of the 1N8026-GA.

```
*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:   1.0           $
*      $Date:      05-SEP-2013   $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*
*      COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
*      ALL RIGHTS RESERVED
*
*      These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
*      OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
*      TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
*      PARTICULAR PURPOSE."
*      Models accurate up to 2 times rated drain current.
*
*      Start of 1N8026-GA SPICE Model
*
.SUBCKT 1N8026 ANODE KATHODE
R1 ANODE INT R=((TEMP-24)*0.0021); Temperature Dependant Resistor
D1 INT KATHODE 1N8026_25C; Call the 25C Diode Model
D2 ANODE KATHODE 1N8026_PIN; Call the PiN Diode Model
.MODEL 1N8026_25C D
+ IS      4.45E-15      RS      0.206
+ N       1.18144      IKF     112.92
+ EG      1.2          XTI     3
+ CJO     3.00E-10     VJ      0.419
+ M       1.6          FC      0.5
+ TT      1.00E-10     BV      1200
+ IBV     1.00E-03     VPK     1200
+ IAVE    5            TYPE    SiC_Schottky
+ MFG     GeneSiC_Semiconductor
.MODEL 1N8026_PIN D
+ IS      2.93E-12      RS      0.35326
+ N       4.6113       IKF     0.0043236
+ EG      3.23         XTI     60
+ FC      0.5          TT      0
+ BV      1200         IBV     1.00E-03
+ VPK     1200         IAVE    2.5
+ TYPE    SiC_PiN
.ENDS
*
*      End of 1N8026-GA SPICE Model
```